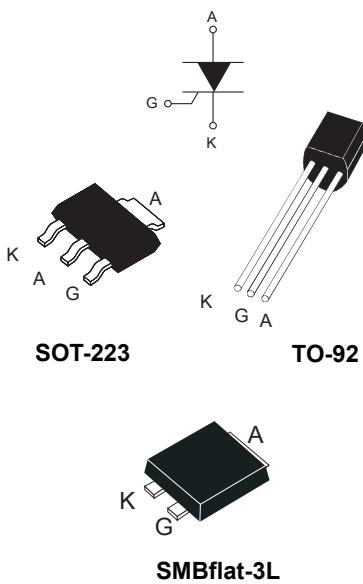


## 1.25 A sensitive gate SCR



### Features

- On-state rms current,  $I_{T(RMS)}$  1.25 A
- Repetitive peak off-state voltage,  $V_{DRM/VRRM}$  600 or 800 V
- Triggering gate current,  $I_{GT\ (Q1)}$  50 to 200  $\mu$ A

### Applications

- Ground fault circuit interrupters
- Overshoot crowbar protection in power supplies
- Capacitive ignition circuits

### Description

The X02 SCR can be used as the on/off function in applications where topology does not offer high current for gate triggering.

This device is optimized in forward voltage drop and inrush current capabilities for reduced power losses and high reliability in harsh environments.

#### Product status link

[X02](#)

#### Product summary

|                    |                   |
|--------------------|-------------------|
| $I_{T(RMS)}$       | 1.25 A            |
| $V_{DRM/VRRM}$     | 600, 800 V        |
| $I_{GT\ standard}$ | 50 to 200 $\mu$ A |

## 1 Characteristics

**Table 1.** Absolute ratings (limiting values,  $T_j = 25^\circ\text{C}$  unless otherwise specified)

| Symbol              | Parameters  |                           |                                      |      | Value                  | Unit |  |
|---------------------|---|---------------------------|--------------------------------------|------|------------------------|------|--|
| $I_{T(\text{RMS})}$ | RMS on-state current (180 ° conduction angle)   | SOT-223                   | $T_{\text{tab}} = 99^\circ\text{C}$  | 1.25 | A                      |      |  |
|                     |   | TO-92                     | $T_L = 63^\circ\text{C}$             |      |                        |      |  |
|                     |   | SMBflat-3L                | $T_{\text{tab}} = 111^\circ\text{C}$ |      |                        |      |  |
| $I_{T(\text{AV})}$  | Average on-state current (180 ° conduction angle)   | SOT-223                   | $T_{\text{tab}} = 99^\circ\text{C}$  | 0.8  | A                      |      |  |
|                     |   | TO-92                     | $T_L = 63^\circ\text{C}$             |      |                        |      |  |
|                     |   | SMBflat-3L                | $T_{\text{tab}} = 111^\circ\text{C}$ |      |                        |      |  |
| $I_{TSM}$           | Non repetitive surge peak on-state current  | $F = 50 \text{ Hz}$       | $t_p = 8.3 \text{ ms}$               | 25   | A                      |      |  |
|                     |   | $F = 60 \text{ Hz}$       | $t_p = 10 \text{ ms}$                | 22.5 |                        |      |  |
| $I^2t$              | $I^2t$ value for fusing   | $t_p = 10 \text{ ms}$     | $T_j = 25^\circ\text{C}$             | 2.5  | $\text{A}^2\text{s}$   |      |  |
| $dI/dt$             | Critical rate of rise of on-state current<br>$I_G = 2 \times I_{GT}, t_r \leq 100 \text{ ns}$ | $F = 60 \text{ Hz}$       | $T_j = 125^\circ\text{C}$            | 50   | $\text{A}/\mu\text{s}$ |      |  |
| $I_{GM}$            | Peak gate current   | $t_p = 20 \mu\text{s}$    | $T_j = 125^\circ\text{C}$            | 1.2  | A                      |      |  |
| $P_{G(\text{AV})}$  | Average gate power dissipation  | $T_j = 125^\circ\text{C}$ |                                      |      | 0.2                    | W    |  |
| $T_{\text{stg}}$    | Storage junction temperature range  |                           |                                      |      | -40 to +150            | °C   |  |
| $T_j$               | Operating junction temperature range  |                           |                                      |      | -40 to +125            | °C   |  |

**Table 2.** Electrical characteristics ( $T_j = 25^\circ\text{C}$ , unless otherwise specified)

| Symbol         | Parameters  | Value |       | Unit |
|----------------|---|-------|-------|------|
|                |   | X0202 | X0205 |      |
| $I_{GT}^{(1)}$ | $V_D = 12 \text{ V}, R_L = 140 \Omega$  | Min.  | 20    | μA   |
|                |   | Max.  | 200   |      |
| $V_{GT}$       |   | Max.  | 0.8   | V    |
| $V_{GD}$       | $V_D = V_{\text{DRM}}, R_L = 3.3 \text{ k}\Omega, R_{\text{GK}} = 1 \text{ k}\Omega, T_j = 125^\circ\text{C}$ | Min.  | 0.1   | V    |
| $V_{RG}$       | $I_{RG} = 10 \mu\text{A}$   | Min.  | 8     |      |
| $I_H^{(2)}$    | $I_T = 50 \text{ mA}, R_{\text{GK}} = 1 \text{ k}\Omega$  | Max.  | 5     | mA   |
| $I_L$          | $I_G = 1 \text{ mA}, R_{\text{GK}} = 1 \text{ k}\Omega$   | Max.  | 6     | mA   |
| $dV/dt^{(2)}$  | $V_D = 67 \% V_{\text{DRM}}, R_{\text{GK}} = 1 \text{ k}\Omega, T_j = 110^\circ\text{C}$                      | Min.  | 10    | V/μs |
|                |   |       | 15    |      |

1. Minimum  $I_{GT}$  is guaranteed at 5 % of  $I_{GT}$  max.

2. For both polarities of A2 referenced to A1

**Table 3. Static electrical characteristics**

| Symbol                 | Test conditions                                    |                           | Value | Unit |
|------------------------|--|---------------------------|-------|------|
| $V_T^{(1)}$            | $I_{TM} = 2.5 \text{ A}$ , $t_p = 380 \mu\text{s}$ | $T_j = 25^\circ\text{C}$  | Max.  | 1.45 |
| $V_{TO}^{(1)}$         | Threshold on-state voltage                         | $T_j = 125^\circ\text{C}$ | Max.  | 0.9  |
| $R_d$                  | Dynamic resistance                                 | $T_j = 125^\circ\text{C}$ | Max.  | 200  |
| $I_{DRM}$<br>$I_{RRM}$ | $V_{DRM} = V_{RRM}$                                | $T_j = 25^\circ\text{C}$  |       | 5    |
|                        |  | $T_j = 125^\circ\text{C}$ | Max.  | 500  |

1. For both polarities of A2 referenced to A1

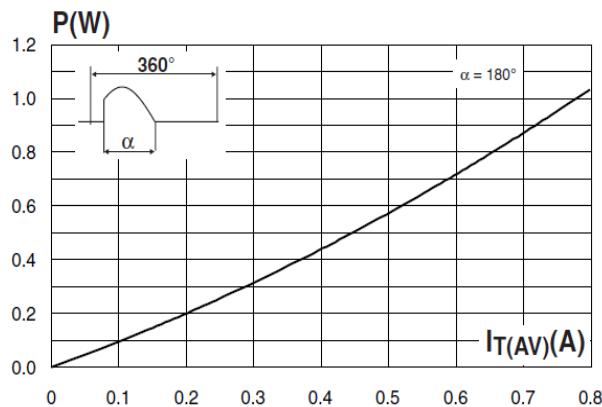
**Table 4. Thermal resistance**

| Symbol        | Parameters   | Max. value | Unit |
|---------------|--|------------|------|
| $R_{th(j-t)}$ | Junction to tab (AC)                               | SOT-223    | 25   |
|               |  | SMBflat-3L | 14   |
| $R_{th(j-l)}$ | Junction to lead (AC)                              | TO-92      | 60   |
| $R_{th(j-a)}$ | Junction to ambient ( $S^{(1)} = 5 \text{ cm}^2$ ) | SOT-223    | 60   |
|               |  | SMBflat-3L | 75   |
|               | Junction to ambient                                | TO-92      | 150  |

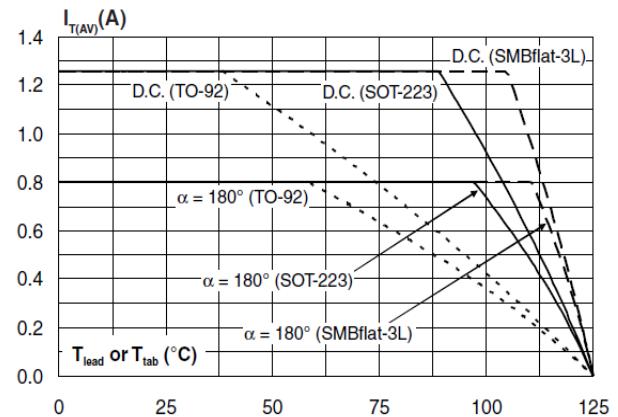
1. Copper surface under tab.

## 1.1 Characteristics (curves)

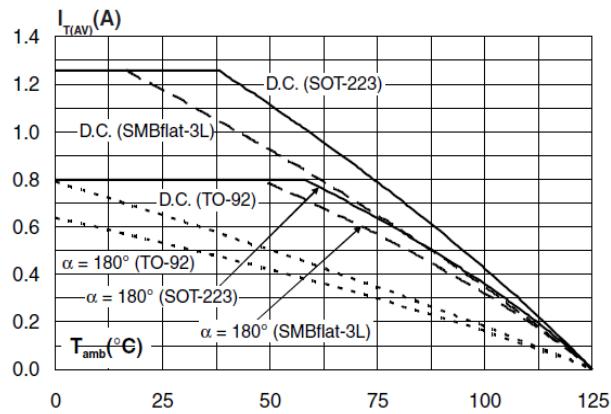
**Figure 1. Maximum power dissipation versus on-state RMS current (full cycle)**



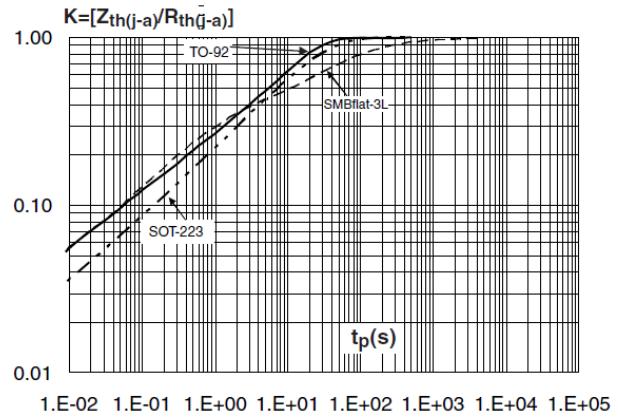
**Figure 2. Average and DC on-state current versus tab (SOT-223, SMBflat-3L) or lead (TO-92) temperature**



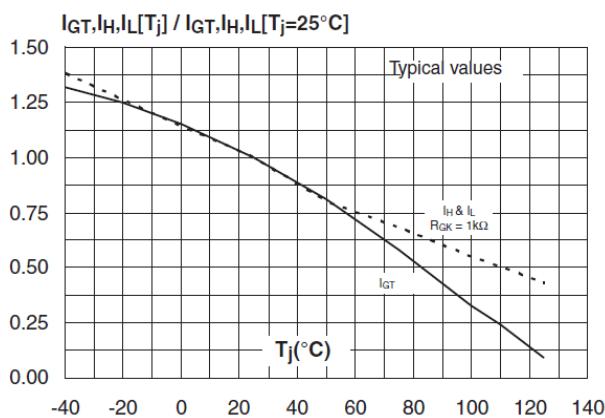
**Figure 3. Average and DC on-state current versus ambient temperature**



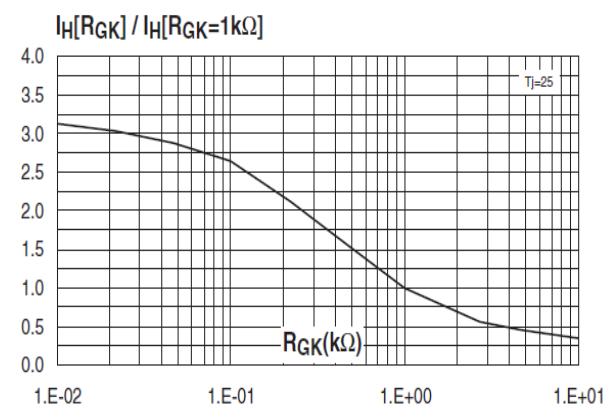
**Figure 4. Relative variation of thermal impedance versus pulse duration**



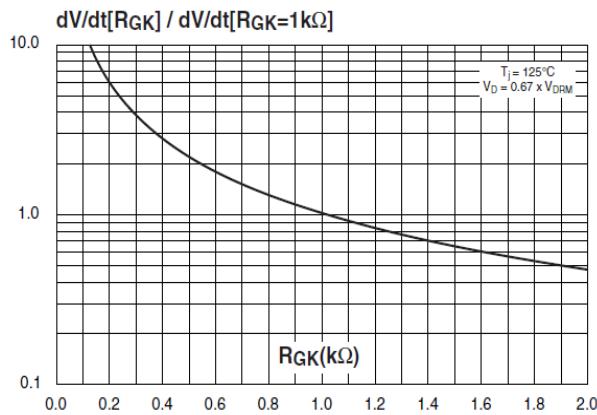
**Figure 5. Relative variation of triggering, holding and latching current versus junction temperature**



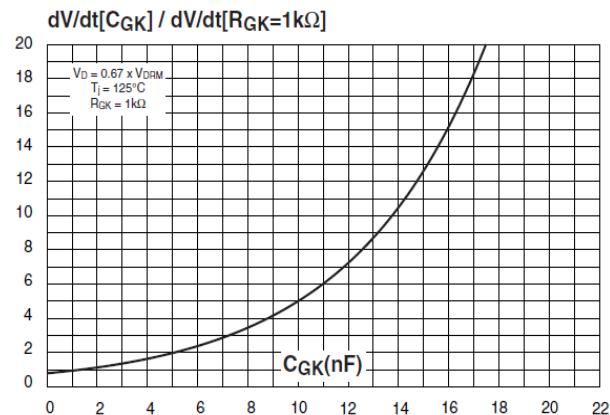
**Figure 6. Relative variation of holding current versus gate-cathode resistance (typical values)**



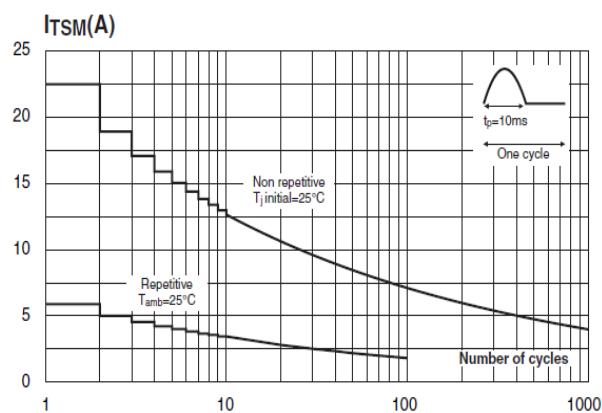
**Figure 7. Relative variation of dV/dt immunity versus gate-cathode resistance (typical values)**



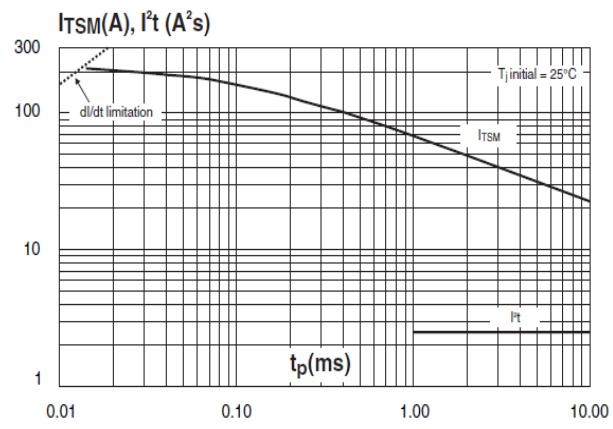
**Figure 8. Relative variation of dV/dt immunity versus gate-cathode capacitance (typical values)**



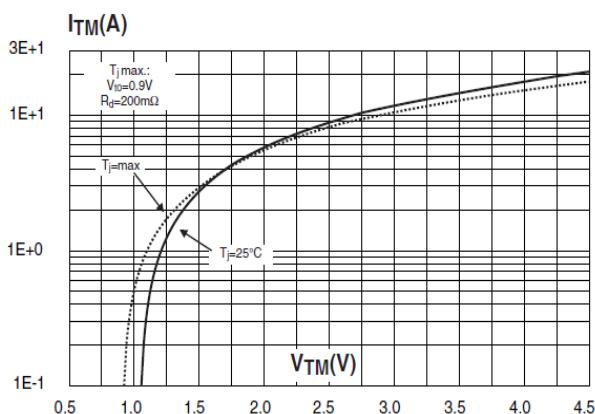
**Figure 9. Surge peak on-state current versus number of cycles**



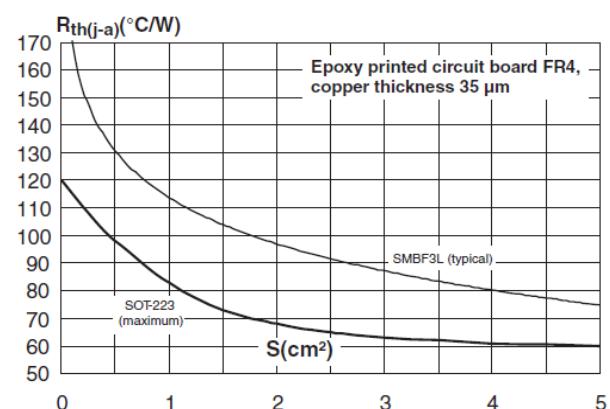
**Figure 10. On-state characteristics (maximum values)**



**Figure 11. On-state characteristics (maximum values)**



**Figure 12. Thermal resistance junction to ambient versus copper surface under tab (SOT-223, SMBflat-3L)**



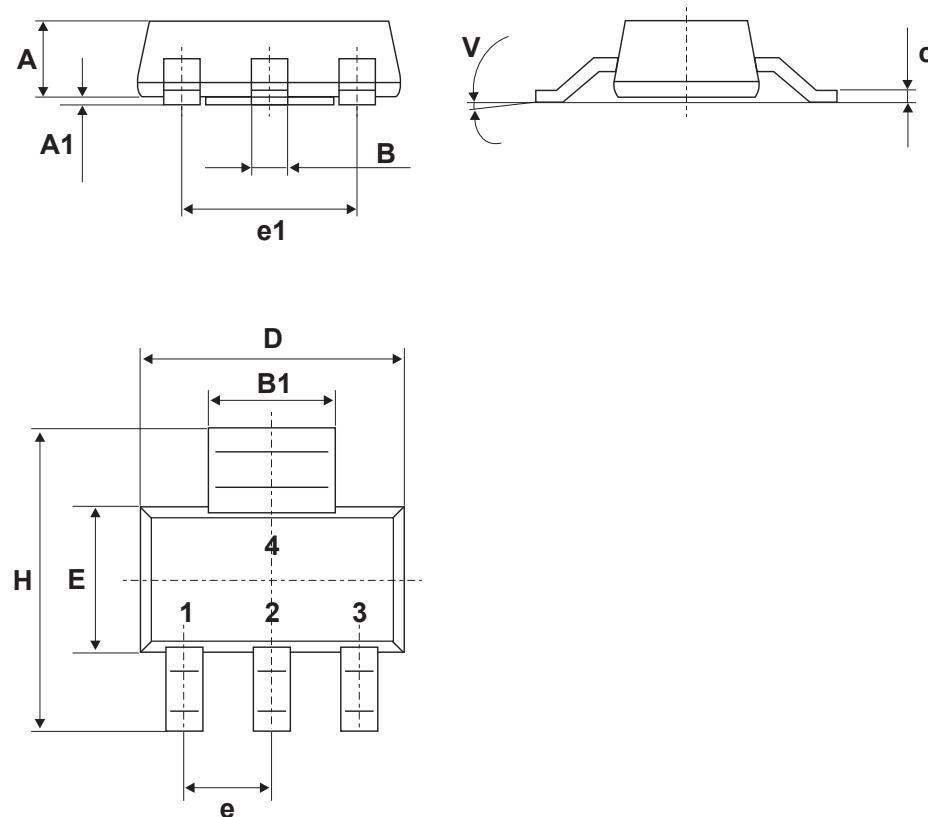
## 2 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK packages, depending on their level of environmental compliance. ECOPACK specifications, grade definitions and product status are available at: [www.st.com](http://www.st.com). ECOPACK is an ST trademark.

### 2.1 SOT-223 package information

- Epoxy meets UL94, V0
- Lead free plating + halogen-free molding resin

Figure 13. SOT-223 package outline

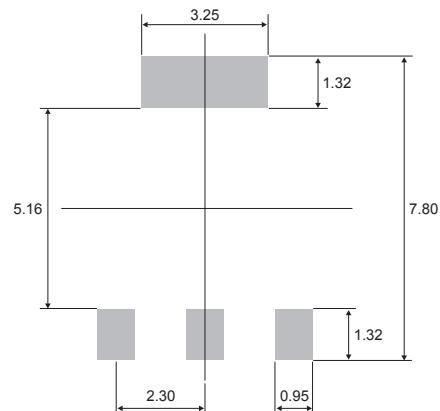


**Table 5.** SOT-223 package mechanical data

| Ref. | Dimensions  |      |      |                       |        |        |
|------|-------------|------|------|-----------------------|--------|--------|
|      | Millimeters |      |      | Inches <sup>(1)</sup> |        |        |
|      | Min.        | Typ. | Max. | Min.                  | Typ.   | Max.   |
| A    |             |      | 1.80 |                       |        | 0.0709 |
| A1   |             | 0.02 | 0.10 |                       | 0.0008 | 0.0039 |
| B    | 0.60        | 0.70 | 0.85 | 0.024                 | 0.0276 | 0.0335 |
| B1   | 2.90        | 3.00 | 3.15 | 0.114                 | 0.1181 | 0.1240 |
| c    | 0.24        | 0.26 | 0.35 | 0.009                 | 0.0102 | 0.0138 |
| D    | 6.30        | 6.50 | 6.70 | 0.248                 | 0.2559 | 0.2638 |
| e    |             | 2.3  |      |                       | 0.0906 |        |
| e1   |             | 4.6  |      |                       | 0.1811 |        |
| E    | 3.30        | 3.50 | 3.70 | 0.130                 | 0.1378 | 0.1457 |
| H    | 6.70        | 7.00 | 7.30 | 0.264                 | 0.2756 | 0.2874 |
| V    | 10° max.    |      |      |                       |        |        |

**1. Inches only for reference**

**Figure 14. SOT-223 footprint (dimensions in mm)**



## 2.2 TO-92 package information

- Lead free plating + halogen-free molding resin
- Epoxy meets UL94, V0

Figure 15. TO-92 package outline

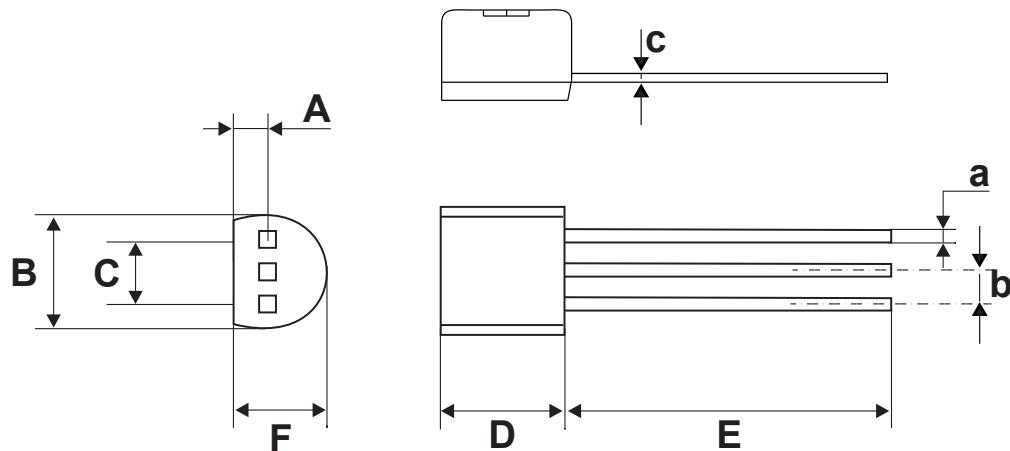


Table 6. TO-92 package mechanical data

| Ref. | Dimensions  |      |      |                       |        |        |
|------|-------------|------|------|-----------------------|--------|--------|
|      | Millimeters |      |      | Inches <sup>(1)</sup> |        |        |
|      | Min.        | Typ. | Max. | Min.                  | Typ.   | Max.   |
| A    |             | 1.35 |      |                       | 0.0531 |        |
| B    |             |      | 4.70 |                       |        | 0.1850 |
| C    |             | 2.54 |      |                       | 0.1000 |        |
| D    | 4.40        |      |      | 0.1732                |        |        |
| E    | 12.70       |      |      | 0.5000                |        |        |
| F    |             |      | 3.70 |                       |        | 0.1457 |
| a    |             |      | 0.50 |                       |        | 0.0197 |
| b    |             | 1.27 |      |                       | 0.0500 |        |
| c    |             |      | 0.48 |                       |        | 0.0189 |

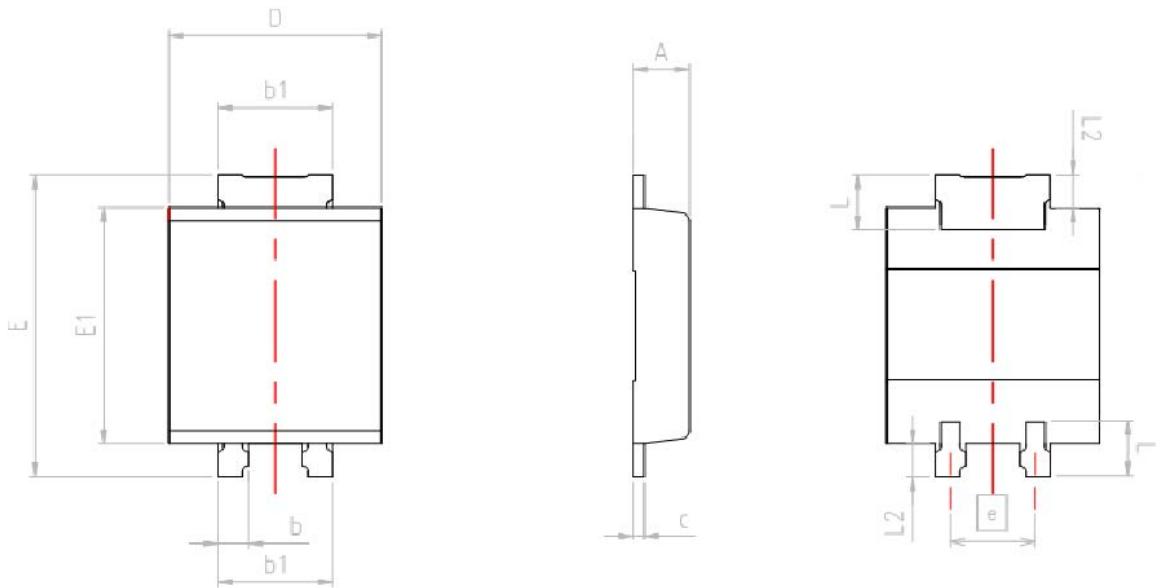
1. Inches dimensions given for information

## 2.3

### SMBflat-3L package information

- Epoxy meets UL94, V0
- Lead-free package

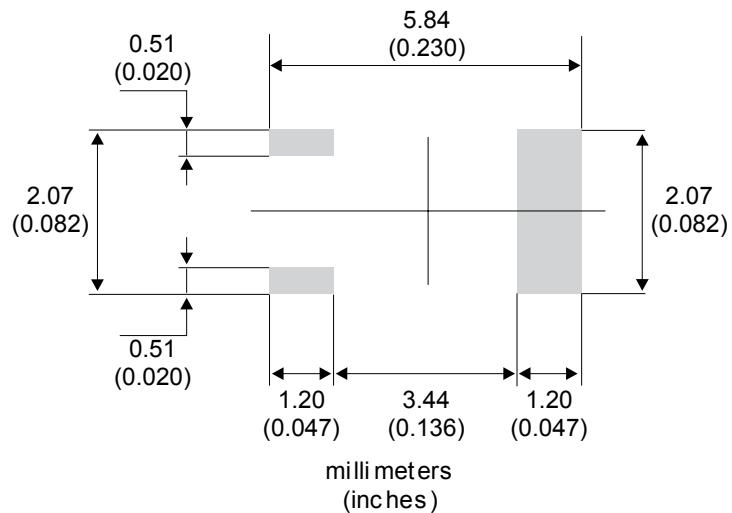
Figure 16. SMBflat-3L package outline



Note: This package drawing may slightly differ from the physical package. However, all the specified dimensions in the following table are guaranteed.

Table 7. SMBflat-3L mechanical data

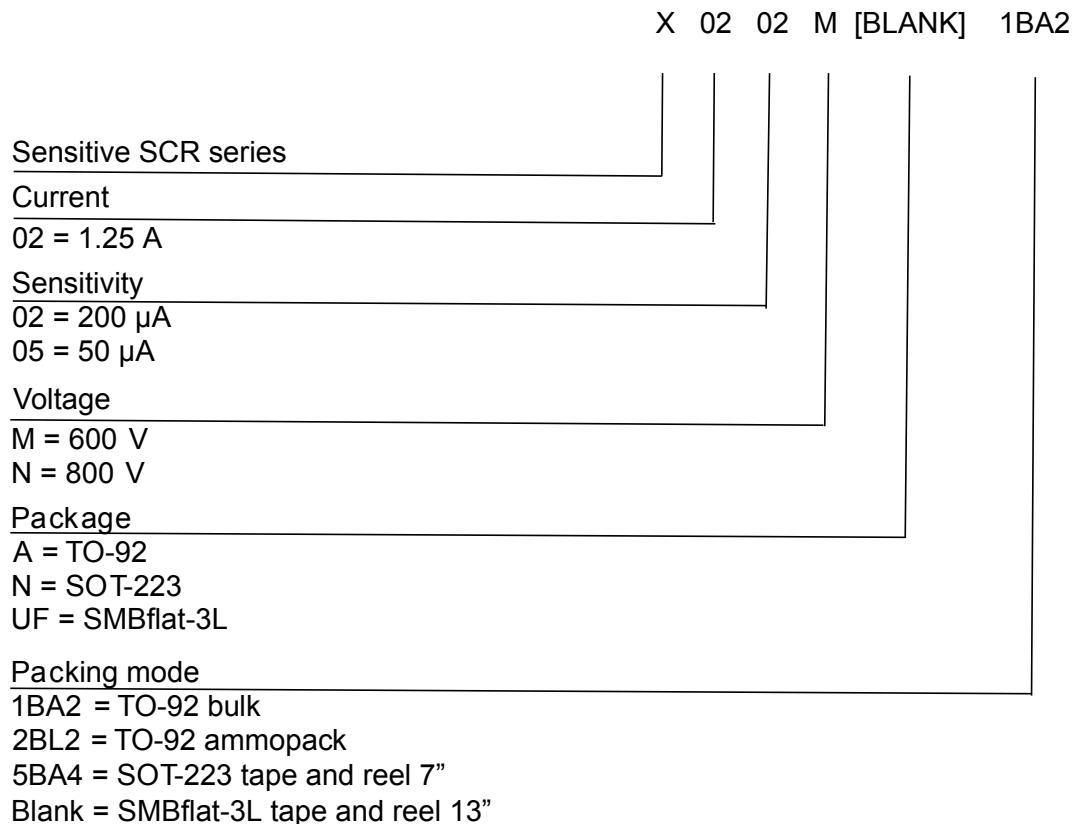
| Ref. | Dimensions  |      |      |  |        |        |
|------|-------------|------|------|--|--------|--------|
|      | Millimeters |      |      | Inches (dimensions are for reference only) |        |        |
|      | Min.        | Typ. | Max. | Min.                                       | Typ.   | Max.   |
| A    | 0.90        |      | 1.10 | 0.0354                                     |        | 0.0433 |
| b    | 0.35        |      | 0.65 | 0.0138                                     |        | 0.0256 |
| b1   | 1.95        |      | 2.20 | 0.0768                                     |        | 0.0866 |
| c    | 0.15        |      | 0.40 | 0.0059                                     |        | 0.0157 |
| D    | 3.30        |      | 3.95 | 0.1299                                     |        | 0.1555 |
| E    | 5.10        |      | 5.60 | 0.2008                                     |        | 0.2205 |
| E1   | 4.05        |      | 4.60 | 0.1594                                     |        | 0.1811 |
| L    | 0.75        |      | 1.50 | 0.0295                                     |        | 0.0591 |
| L2   |             | 0.60 |      |  | 0.0236 |        |
| e    |             | 1.60 |      |  | 0.0630 |        |

**Figure 17. Footprint recommendations, dimensions in mm (inches)**

**Note:** This drawing may not be in scale; however, all the specified dimensions are guaranteed.

### 3 Ordering information

**Figure 18. Ordering information scheme**



**Table 8. Ordering information**

| Order code   | Marking  | Package    | Weight | Base qty. | Delivery mode |
|--------------|----------|------------|--------|-----------|---------------|
| X0202MA 1BA2 | X0202 MA | TO-92      | 0.2 g  | 2500      | Bulk          |
| X0202MA 2BL2 | X0202 MA |            |        | 2000      | Ammopack      |
| X0202MN5BA4  | X2M      | SOT-223    | 0.12 g | 1000      | Tape and reel |
| X0202NA 1BA2 | X0202 NA | TO-92      | 0.2 g  | 2500      | Bulk          |
| X0202NA 2BL2 | X0202 NA |            |        | 2000      | Ammopack      |
| X0202NN5BA4  | X2N      | SOT-223    | 0.12 g | 1000      | Tape and reel |
| X0205MA 1BA2 | X0205 MA | TO-92      | 0.2 g  | 2500      | Bulk          |
| X0205MA 2BL2 | X0205 MA |            |        | 2000      | Ammopack      |
| X0205NA 1BA2 | X0205 NA |            |        | 2500      | Bulk          |
| X0202NUF     | X2N      | SMBflat-3L | 47 mg  | 5000      | Tape and reel |

**Table 9. Product selector**

| Part number | Voltage (xxx) |     | Sensitivity $\mu\text{A}$ | Package    |
|-------------|---------------|-----|---------------------------|------------|
|             | 600           | 800 |                           |            |
| X0202MA     | X             |     | 200                       | TO-92      |
| X0202MN     | X             |     | 200                       | SOT-323    |
| X0202NA     |               | X   | 200                       | TO-92      |
| X0202NN     |               | X   | 200                       | SOT-323    |
| X0205MA     | X             |     | 50                        | TO-92      |
| X0205NA     |               | X   | 50                        | TO-92      |
| X0202NUF    |               | X   | 200                       | SMBflat-3L |

## Revision history

**Table 10. Document revision history**

| Date        | Revision | Changes   |
|-------------|----------|---|
| Sep-2000    | 3        | Previous issue  |
| 14-Jan-2011 | 4        | Added SMBflat-3L package and ECOPACK statement.                                     |
| 17-Apr-2023 | 5        | Updated <a href="#">Figure 16</a> and <a href="#">Table 7</a> . Minor text changes. |
| 19-Jul-2023 | 6        | Updated <a href="#">Table 8</a> .   |

**IMPORTANT NOTICE – READ CAREFULLY**

STMicroelectronics NV and its subsidiaries ("ST") reserve the right to make changes, corrections, enhancements, modifications, and improvements to ST products and/or to this document at any time without notice. Purchasers should obtain the latest relevant information on ST products before placing orders. ST products are sold pursuant to ST's terms and conditions of sale in place at the time of order acknowledgment.

Purchasers are solely responsible for the choice, selection, and use of ST products and ST assumes no liability for application assistance or the design of purchasers' products.

No license, express or implied, to any intellectual property right is granted by ST herein.

Resale of ST products with provisions different from the information set forth herein shall void any warranty granted by ST for such product.

ST and the ST logo are trademarks of ST. For additional information about ST trademarks, refer to [www.st.com/trademarks](http://www.st.com/trademarks). All other product or service names are the property of their respective owners.

Information in this document supersedes and replaces information previously supplied in any prior versions of this document.

© 2023 STMicroelectronics – All rights reserved